

TO. : _____

NO. : _____






APPROVAL SHEET

MULTILAYER CERAMIC CAPACITOR
Commercial Grade
(Thin Layer Large-Capacitance Type)

Approved by customer : (signing or stamping here)

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SAMWHA CAPACITOR CO., LTD.		
Written by	Checked by	Approved by
		

2020. 03. 11.



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Home page : www.samwha.com

< SPEC SUMMARY >

SAMWHA Part no.	CS1005X7R104K500NR		
Type	Thin Layer Large-Capacitance		
Item	Specification	Unit	Test methods and Conditions(Capacitance,IR)
Capacitance	100	nF	Testing Frequency : 1 ±0.1kHz Testing Voltage : 1 ±0.2Vrms
Capacitance Tolerance	± 10	%	
Dissipation Factor	Max. 12.5	%	
Insulation Resistance	More than 500	MΩ	Applied the rated voltage for 2 minutes of charging.
Chip Size	1.00 ±0.05	L (mm)	*Capacitance Tolerance Code --- page 1/8 *Chip size ----- page 2/8 *Characteristics & Test Method----- page 3/8~5/8
	0.50 ±0.05	W (mm)	
	0.50 ±0.05	T (mm)	

Enactment : March 27,1996	STANDARD	NO	SW - M - 04B
	MULTILAYER CERAMIC CAPACITOR Commercial Grade	Page	1 / 8

1. General Article

Application Range

These specifications refer to the "Multilayer Ceramic Capacitors "mainly used to the computer equipment, communication equipment.

***Caution : Industrial equipment / For the high reliability equipment / LED equipment / Etc.
Please contact sales representatives or product engineers before using the products.
(For details, please refer Page 8)**

2. General Code

(1) Type Designation

CS 1005 X7R 104 K 500 N R
 (1) (2) (3) (4) (5) (6) (7) (8) (9)

1) Multilayer Ceramic Capacitor (Commercial Grade)

2) Size Code :

This is expressed in tens of a millimeter.
The first two digits are the length, The last two digits are width.

3) Temperature Coefficient Code

Classification	Code	Temperature Range	Capacitance Tolerance
Class I	C0G	-55 to +125°C	±30 ppm/°C
Class II	X5R	-55 to +85°C	±15%
	X7R	-55 to +125°C	±15%
	X7S	-55 to +125°C	±22%
	X7T	-55 to +125°C	+22% ~ -33%
	Y5V	-30 to +85°C	+22% ~ -82%

4) Capacitance Code(Pico farads) :

The nominal Capacitance Value in pF is expressed by three digit numbers.

The first two digits represents significant figures and the last digit denotes the number of zero

ex) 104 = 100000 pF

R denotes decimal

8R2 = 8.2 pF

5) Capacitance Tolerance Code

Code	Tolerance
B	± 0.1 pF
C	± 0.25 pF
D	± 0.5 pF
F	± 1.0 %
G	± 2.0 %
J	± 5 %
K	± 10 %

Code	Tolerance
M	± 20 %
P	+ 100, - 0%
Z	+ 80, - 20%
H	+ 0.25/-0 pF
I	+ 0/-0.25 pF
U	+ 5/-0 %
V	+ 0/-5 %

6) Voltage Code

code	6R3	100	160	250	350	500	101	201	251	501	631	102	202	302
Vol.	DC 6.3V	DC 10V	DC 16V	DC 25V	DC 35V	DC 50V	DC 100V	DC 200V	DC 250V	DC 500V	DC 630V	DC 1KV	DC 2KV	DC 3KV

7) Termination Code

ex) N : Ni-Sn (Nickel-Tin Plate)

A : Ag/Ni-Sn (Ag Epoxy/Nickel-Tin Plate) -> **Soft Termination Type**

8) Packing Code

ex) R : 7" Reel Type

L : 13" Reel Type

B : Bulk Type

9) Thickness option

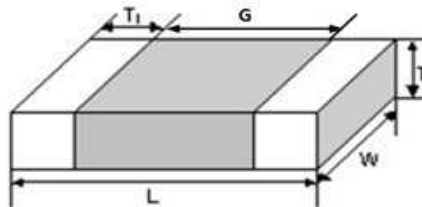
Thickness(mm)		Code	Thickness(mm)		Code
t	Tol(±)		t	Tol(±)	
0.30	0.03	Blank	1.30	0.20	E
0.50	0.05	Blank	1.35	0.20	H
0.60	0.10	A	1.60	0.20	I
0.80	0.10	B	1.80	0.20	J
0.85	0.15	B	2.00	0.25	K
1.00	0.15	E	2.50	0.25	L
1.10	0.15	E	2.80	0.30	M
1.15	0.15	E	3.20	0.30	N
1.25	0.15	E	5.00	0.40	O

3. Temperature Characteristics

See Page 5/8 (No.13)

4. Constructions and Dimensions

(1) Dimensions



(Unit : mm)

Code	Dimension					
	Length		Width		T1(min)	G(min)
	L	Tol(±)	W	Tol(±)		
0603	0.60	0.03	0.30	0.03	0.05	0.15
1005	1.00	0.05	0.50	0.05	0.05	0.30
1608	1.60	0.15	0.80	0.10	0.10	0.50
2012	2.00	0.20	1.25	0.15	0.10	0.65
3216	3.20	0.30	1.60	0.20	0.15	1.00
3225	3.20	0.40	2.50	0.25	0.15	1.05
4520	4.50	0.40	2.00	0.25	0.20	1.50
4532	4.50	0.40	3.20	0.30	0.20	1.50
5750	5.70	0.50	5.00	0.40	0.30	1.85

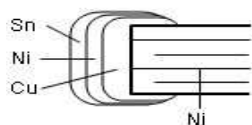
*1005 Size $\geq 4.7\mu F \Rightarrow L, W, T : Tol \pm 0.15$

*1608 Size $\geq 10\mu F \Rightarrow W : 0.80 \pm 0.15, T : 0.80 \pm 0.15$

*2012 Size $\geq 10\mu F \Rightarrow W : 1.25 \pm 0.20, T : 0.85 \pm 0.15$

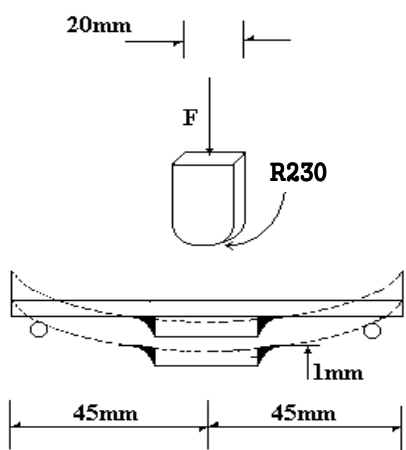
*3216 Size $\geq 47\mu F \Rightarrow W : 1.60 \pm 0.30, T : 1.60 \pm 0.30$

(2) Construction of Termination



Specifications and Test Methods (Thin Layer Large-Capacitance Type)

No.	Item	Specification	Test Methods and Conditions															
1	Operating Temperature Range	X7R, X7S, X7T : -55 to +125°C X5R : -55 to +85°C Y5V : -30 to +85°C																
2	Insulation Resistance	50Ω·F min	·Applied the rated voltage for 2 minutes of charging. The charge/discharge current is less than 50mA.															
3	Dielectric Strength	No defects or abnormalities	X7R, X7S, X7T, X5R, Y5V : The rated voltage × 250% - Applied between the terminations for 1 to 5 seconds. - The charge/discharge current is less than 50mA.															
4	Capacitance	within the specified tolerance	The capacitance/D.F. should be measured at 25°C at the frequency and voltage shown in the table.															
5	Dissipation Factor	X7R, X7S, X7T, X5R : 12.5%max *3216 Size 100μF : 15%max Y5V : 20%max	<table border="1"> <thead> <tr> <th>Capacitance</th> <th>Frequency</th> <th>Voltage</th> </tr> </thead> <tbody> <tr> <td>C ≤ 10μF</td> <td>1 ± 0.1kHz</td> <td>0.5~1.0Vrms</td> </tr> <tr> <td>C > 10μF</td> <td>120 ± 24Hz</td> <td>0.5±0.1Vrms</td> </tr> </tbody> </table>	Capacitance	Frequency	Voltage	C ≤ 10μF	1 ± 0.1kHz	0.5~1.0Vrms	C > 10μF	120 ± 24Hz	0.5±0.1Vrms						
			Capacitance	Frequency	Voltage													
C ≤ 10μF	1 ± 0.1kHz	0.5~1.0Vrms																
C > 10μF	120 ± 24Hz	0.5±0.1Vrms																
<ul style="list-style-type: none"> Initial measurement Perform the initial measurement according to Note1 for Class II Measurement after test Take it out and set it for 24±2 hours (Class II) then measure 																		
6	Solderability of Termination	-Termination should be covered with more than 75% of new solder	*Pb-Free type Solder : 96.5Sn-3Ag-0.5Cu Solder temperature : 245±5°C Immersion time : 3±0.1sec *Pre-Heating : at 80~120°C for 10~30sec															
7	Resistance to Soldering Heat	Appearance	No defects which may affect performance															
		Capacitance change	X7R, X7S, X7T, X5R : Within±7.5% Y5V : Within±20%															
		Dissipation Factor	X7R, X7S, X7T, X5R : 12.5%max *3216 Size 100μF : 15%max Y5V : 20%max															
		I.R.	50Ω·F min															
			Preheat the capacitor at 120 to 150°C for 1 minute. (Preheating for 3225,4520,4532 Step1:100°C to 120°C, 1min Step2:170°C to 200°C, 1min) Immerse the capacitor in a eutectic solder solution at 260±5°C for 10±0.5 seconds.															
			·Initial measurement Perform the initial measurement according to Note1 for Class II ·Measurement after test Let sit at room temperature for 24±2 hours,then measure.															
8	Temperature Cycle	Appearance	No defects which may affect performance															
		Capacitance Change	X7R, X7S, X7T, X5R : Within ±7.5% Y5V : Within ±20%															
		Dissipation Factor	X7R, X7S, X7T, X5R : 12.5%max *3216 Size 100μF : 15%max Y5V : 20%max															
		I.R.	50Ω·F min															
			Perform the five cycles according to the four heat treatments listed in the following table.															
			<table border="1"> <thead> <tr> <th>Step</th> <th>1</th> <th>2</th> <th>3</th> <th>4</th> </tr> </thead> <tbody> <tr> <td>Temp (°C)</td> <td>Min. operating temp. +0/-3</td> <td>Room Temp</td> <td>Max. operating temp. +3/-0</td> <td>Room Temp</td> </tr> <tr> <td>Time (min)</td> <td>30±3</td> <td>2 to3</td> <td>30±3</td> <td>2 to3</td> </tr> </tbody> </table>	Step	1	2	3	4	Temp (°C)	Min. operating temp. +0/-3	Room Temp	Max. operating temp. +3/-0	Room Temp	Time (min)	30±3	2 to3	30±3	2 to3
Step	1	2	3	4														
Temp (°C)	Min. operating temp. +0/-3	Room Temp	Max. operating temp. +3/-0	Room Temp														
Time (min)	30±3	2 to3	30±3	2 to3														
			·Initial measurement Perform the initial measurement according to Note1 for Class II ·Measurement after test Perform the final measurement according to Note2															

No.	Item	Specification	Test Methods and Conditions								
9	High Temperature Load	<table border="1"> <tr> <td data-bbox="300 235 454 324">Appearance</td> <td data-bbox="454 235 944 324">No defects which may affect performance</td> </tr> <tr> <td data-bbox="300 324 454 414">Capacitance Change</td> <td data-bbox="454 324 944 414">X7R, X7S, X7T, X5R : Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$</td> </tr> <tr> <td data-bbox="300 414 454 526">Dissipation Factor</td> <td data-bbox="454 414 944 526">X7R, X7S, X7T, X5R : 20%max *3216 Size 100μF : 30%max Y5V : 40%max</td> </tr> <tr> <td data-bbox="300 526 454 660">I.R</td> <td data-bbox="454 526 944 660">12.5Ω·F min</td> </tr> </table>	Appearance	No defects which may affect performance	Capacitance Change	X7R, X7S, X7T, X5R : Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$	Dissipation Factor	X7R, X7S, X7T, X5R : 20%max *3216 Size 100 μ F : 30%max Y5V : 40%max	I.R	12.5 Ω ·F min	<p>Apply 150% of the rated voltage for 1000+48/-0 hrs at the maximum operating temperature $\pm 3^{\circ}\text{C}$. The charge/discharge current is less than 50mA.</p> <p>-Initial measurement Perform the initial measurement according to Note1 for Class II</p> <p>-Measurement after test Perform the final measurement according to Note2</p>
Appearance	No defects which may affect performance										
Capacitance Change	X7R, X7S, X7T, X5R : Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$										
Dissipation Factor	X7R, X7S, X7T, X5R : 20%max *3216 Size 100 μ F : 30%max Y5V : 40%max										
I.R	12.5 Ω ·F min										
10	Bending strength	 <p>No cracking or marking defects shall occur</p> <table border="1"> <tr> <td data-bbox="300 1220 454 1288">Capacitance Change</td> <td data-bbox="454 1220 944 1288">X7R, X7S, X7T, X5R: Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$ Within +30/-40% (cap$\geq 10\mu$F)</td> </tr> </table>	Capacitance Change	X7R, X7S, X7T, X5R: Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$ Within +30/-40% (cap $\geq 10\mu$ F)	<p>·Substrate material : Glass EPOXY Board.</p> <p>·Thickness : 1.6mm 0.8mm(0603/1005size)</p> <p>*. Test condition - Bending limit : 1mm - Pressurizing speed : 1mm/sec - Holding time : 5\pm1sec</p>						
Capacitance Change	X7R, X7S, X7T, X5R: Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$ Within +30/-40% (cap $\geq 10\mu$ F)										
11	Vibration Resistance	<table border="1"> <tr> <td data-bbox="300 1310 454 1355">Appearance</td> <td data-bbox="454 1310 944 1355">No defects or abnormalities</td> </tr> <tr> <td data-bbox="300 1355 454 1422">Capacitance</td> <td data-bbox="454 1355 944 1422">Whin the specified tolerance</td> </tr> <tr> <td data-bbox="300 1422 454 1668">Dissipation Factor</td> <td data-bbox="454 1422 944 1668">X7R, X7S, X7T, X5R : 12.5%max *3216 Size 100μF : 15%max Y5V : 20%max</td> </tr> </table>	Appearance	No defects or abnormalities	Capacitance	Whin the specified tolerance	Dissipation Factor	X7R, X7S, X7T, X5R : 12.5%max *3216 Size 100 μ F : 15%max Y5V : 20%max	<p>*Shown in Fig. After soldering and then let sit for 24\pm2hr at room temperature. The capacitor should be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz, shall be traversed(from 10Hz to 55Hz then 10Hz again) in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3mutually perpendicular directions(total is 6hours).</p>		
Appearance	No defects or abnormalities										
Capacitance	Whin the specified tolerance										
Dissipation Factor	X7R, X7S, X7T, X5R : 12.5%max *3216 Size 100 μ F : 15%max Y5V : 20%max										
12	Humidity Load	<table border="1"> <tr> <td data-bbox="300 1691 454 1758">Appearance</td> <td data-bbox="454 1691 944 1758">No defects which may affect performance</td> </tr> <tr> <td data-bbox="300 1758 454 1848">Capacitance Change</td> <td data-bbox="454 1758 944 1848">X7R, X7S, X7T, X5R: Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$</td> </tr> <tr> <td data-bbox="300 1848 454 1960">Dissipation Factor</td> <td data-bbox="454 1848 944 1960">X7R, X7S, X7T, X5R : 20%max *3216 Size 100μF : 30%max Y5V : 40%max</td> </tr> <tr> <td data-bbox="300 1960 454 2060">I.R.</td> <td data-bbox="454 1960 944 2060">12.5Ω·F min</td> </tr> </table>	Appearance	No defects which may affect performance	Capacitance Change	X7R, X7S, X7T, X5R: Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$	Dissipation Factor	X7R, X7S, X7T, X5R : 20%max *3216 Size 100 μ F : 30%max Y5V : 40%max	I.R.	12.5 Ω ·F min	<p>Apply the rated voltage at 40\pm2$^{\circ}\text{C}$ and 90 to 95%RH for 500+24/-0 hrs. The charge/discharge current is less than 50mA.</p> <p>·Initial measurement Perform the initial measurement according to Note1 for Class II</p> <p>·Measurement after test Perform the final measurement according to Note2</p>
Appearance	No defects which may affect performance										
Capacitance Change	X7R, X7S, X7T, X5R: Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$										
Dissipation Factor	X7R, X7S, X7T, X5R : 20%max *3216 Size 100 μ F : 30%max Y5V : 40%max										
I.R.	12.5 Ω ·F min										

No.	Item	Specification				Test Methods and Conditions
13	Capacitance Temperature Characteristics	Char.	Temp. Range	Reference Temp.	Cap. Change	<p>The capacitance change should be measured after 5 min. at each specified temperature stage.</p> <p>The ranges of capacitance change compared with the 25°C value over the temperature ranges shown in the table should be within the specified ranges.</p>
		X5R	-55 to +85°C	25°C	Within ±15%	
		X7R	-55 to +125°C	25°C	Within ±15%	
		X7S	-55 to +125°C	25°C	Within ±22%	
		X7T	-55 to +125°C	25°C	Within +22/-33%	
Y5V	-30 to +85°C	25°C	Within +22/-82%			

*Note1. Initial Measurement for Class II

Perform a heat treatment at 150+0,-10°C for one hour and then let sit for 24±2 hours at room temperature, then measure

*Note2. Measurement after test

Class II

Perform a heat treatment at 150+0,-10°C for one hour and then let sit for 24±2 hours at room temperature, then measure.

5. Packing

(1) Bulk packing

- ① 1000 pcs per Polybag
- ② 5 Polybags per Inner box
- ③ 10 Inner boxes per Out box

(2) Reel Packing

- ① 8~10 Reels per Inner box
- ② 6 Inner boxes per Out box

(3) Reel Dimensions



(Unit : mm)

MARK	SIZE	A	B	C	D	E	W
7 " REEL	0603~3225	$\Phi 178 \pm 2$	$\Phi 50 \text{Min}$	$\Phi 13 \pm 0.5$	$\Phi 21 \pm 0.8$	2 ± 0.5	10 ± 1.5
	4520~4532	$\Phi 180 +0, -3$	$\Phi 60 -0, +1$	$\Phi 13 \pm 0.2$	$\Phi 57 -0 +1$	3 ± 0.2	13 ± 0.5
13 " REEL	1005~3225	$\Phi 330 \pm 2$	$\Phi 70 \text{Min}$	$\Phi 13 \pm 0.5$	$\Phi 21 \pm 0.8$	2 ± 0.5	10 ± 1.5

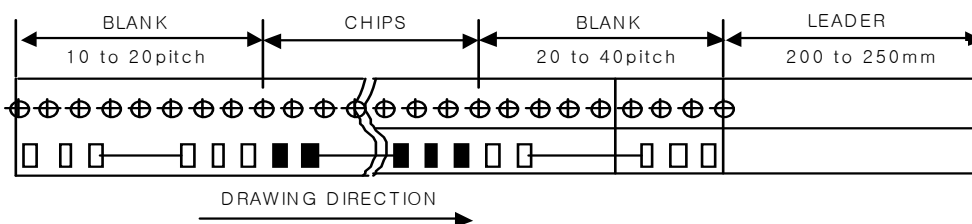
(4) Number of Package

TYPE	EIA CODE	7"	13"
		Qt/REEL	Qt/REEL
CS0603	CC0201	15,000	
CS1005	CC0402	10,000	50,000
CS1608	CC0603	4,000	15,000
CS2012	CC0805	3,000 ~ 4,000	8,000 ~ 15,000
CS3216	CC1206	2,000 ~ 4,000	6,000 ~ 10,000
CS3225	CC1210	1,000 ~ 3,000	4,000 ~ 10,000
CS4520	CC1808	1,500 ~ 3,000	-
CS4532	CC1812	500 ~ 1,000	1,500 ~ 5,000

(5) Tape Dimensions



TYPE	EIA CODE	A	B	C	D	E	F	G	H	J
CS0603	CC0201	0.67 ± 0.05	0.37 ± 0.05	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	2.0 ± 0.05	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS1005	CC0402	1.15 ± 0.1	0.65 ± 0.1	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	2.0 ± 0.05	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS1608	CC0603	1.9 ± 0.2	1.10 ± 0.2	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	4.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS2012	CC0805	2.4 ± 0.2	1.65 ± 0.2	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	4.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS3216	CC1206	3.6 ± 0.2	2.00 ± 0.2	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	4.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS3225	CC1210	3.6 ± 0.2	2.80 ± 0.2	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	4.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS4520	CC1808	4.8 ± 0.2	2.3 ± 0.2	12.0 ± 0.3	5.5 ± 0.1	1.75 ± 0.1	4.0 ± 0.1 8.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS4532	CC1812	4.9 ± 0.2	3.6 ± 0.2	12.0 ± 0.3	5.5 ± 0.1	1.75 ± 0.1	8.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1



6. Caution

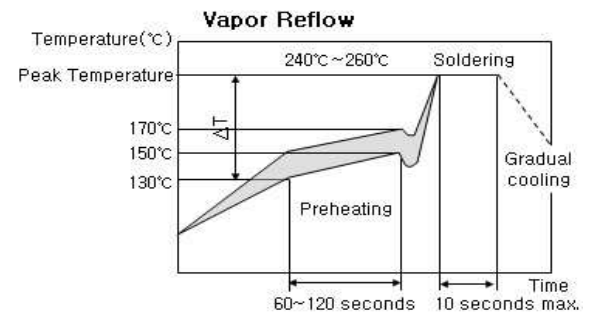
▶ Reflow Soldering

1. The sudden temperature change easily causes mechanical damages to ceramic components. Therefore, the preheating procedures should be required for the soldering of ceramic components.
2. Please refer to the recommended soldering profiles as shown in figures, and keep the temperature difference(ΔT) within the range recommended in Table 1.

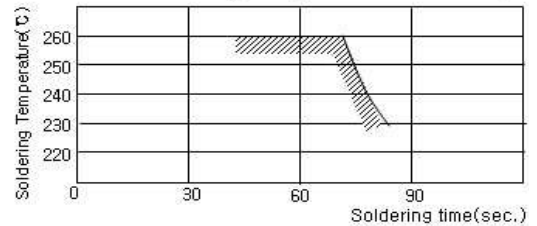
Table 1

Size code	Temperature Difference
0603, 1005, 1608, 2012, 3216	$\Delta T \leq 190^\circ\text{C}$
3225size and over	$\Delta T \leq 130^\circ\text{C}$

[Standard Conditions for Reflow Soldering]



[Allowable Soldering Temperature and Time]



In case of repeated soldering, the accumulated soldering time must be within the range shown above.

▶ Storage Condition

*When Solderability is considered, Capacitor are recommended to be used in 12 months

- (1) Temperature: 25°C ± 10°C
- (2) Relative Humidity: Below 70% RH

▶ The Regulation of Environmental Pollution Materials.

*Never use materials mentioned below in MLCC products regulated this document.

Pb, Cd, Hg, Cr⁺⁶, PBB(Polybromide biphenyl), PBDE(Polybrominated diphenyl ethers), asbestos.

* Note

(1) 'Aging'/'De-aging' Behavior of high dielectric MLCCs

(Typically represented by X7R, Y5V temperature characteristic of which main composition is BaTiO₃)

'Aging' / 'De-aging' Behavior of high dielectric MLCCs Please note that high dielectric type dielectric Ceramic Capacitors have a "normal" 'aging' behavior / characteristic, that is; their capacitance value decreases with time from its value when it was first manufactured. From that date, the capacitance value begins to decrease at a logarithmic rate defined by:

$$C_t = C_{24} (1 - k \log_{10} t)$$

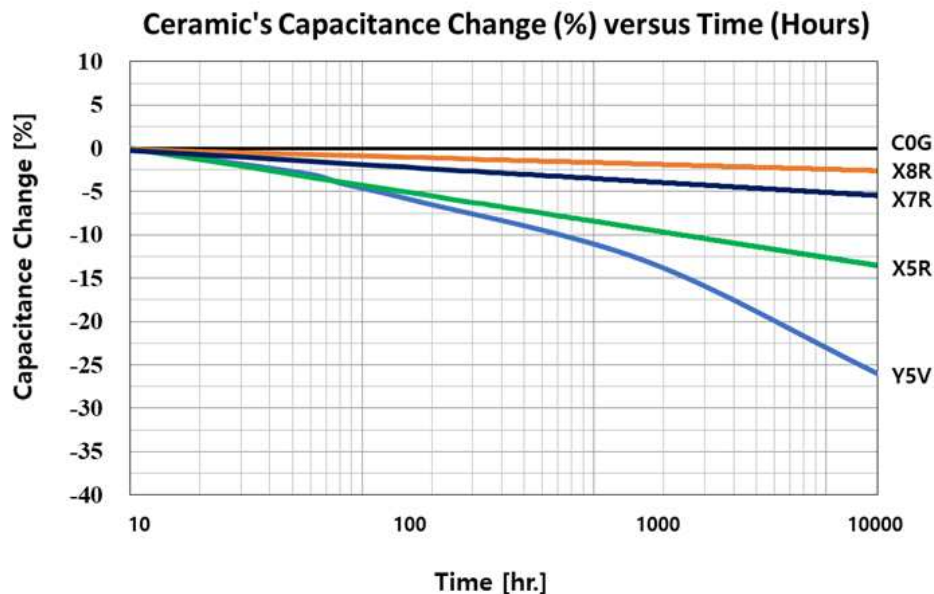
where :

C_t = Capacitance Value, t hours after the start of 'aging'

C_{24} = Capacitance Value, 24 hours after its manufacture

k = aging constant (capacitance decrease per decade-hour)

t = time, in hours, from the start of 'aging'



The capacitance value can be restored (a.k.a. 'de-aged') by exposing the component to elevated temperatures approaching its Curie Temperature (approximately 120°C). This 'deaging' can occur during the component's solder-assembly onto the PCB, during life or temperature cycle testing., or by ' baking ' at 150°C for about 1 hour.

(2) Please contact our sales representatives or product engineers before using the products in this catalog for the applications listed below, which require especially high reliability for the prevention of defects which might directly damage a third party's life, body or property, or when one of our products is intended for use in applications other than those specified in this catalog.

- ① Aircraft equipment ② Aerospace equipment ③ Undersea equipment ④ Power plant equipment
- ⑤ Medical equipment ⑥ Transportation equipment (vehicles, trains, ships, etc.)
- ⑦ Traffic signal equipment ⑧ Disaster prevention / crime prevention equipment
- ⑨ Industrial equipment (Conveyors, Robot equipment, etc) ⑩ Led equipment
- ⑪ Application of similar complexity and/or reliability requirements to the applications listed above